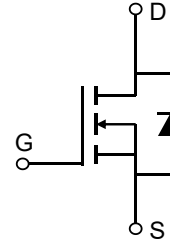


Description

Features

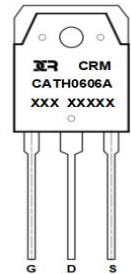
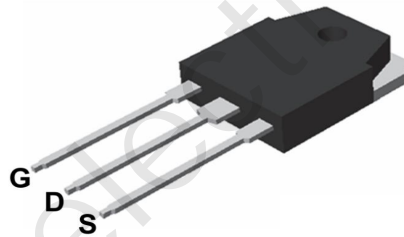
- 60V, 94A
 $R_{DS(ON)}$ Typ = 5.7mΩ @ $V_{GS} = 10V$
 Advanced Trench Technology
- Excellent $R_{DS(ON)}$ and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔV_{ds} TESTED!



Schematic Diagram

Application

- Load Switch
- PWM Application
- Power Management



Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	TUBE(pcs)	Inner Box (pcs)	Per Carton (pcs)
CRMCATH0606A	CRMCATH0606A	TO-3P-3L	TUBE	30	480	2400

Absolute Maximum Ratings (@ $T_J = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Value	Units
V_{DS}	Drain-to-Source Voltage	60	V
V_{GS}	Gate-to-Source Voltage	±20	V
I_D	Continuous Drain Current	$T_C = 25^\circ\text{C}$	94
		$T_C = 100^\circ\text{C}$	56.4
I_{DM}	Pulsed Drain Current ⁽¹⁾	376	A
E_{AS}	Single Pulsed Avalanche Energy ⁽²⁾	176	mJ
P_D	Power Dissipation	$T_C = 25^\circ\text{C}$	119
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.05	°C/W
T_J, T_{STG}	Junction & Storage Temperature Range	-55 to 150	°C

Electrical Characteristics ($T_J = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
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Off Characteristics

$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$I_D = 250\mu\text{A}$, $V_{GS} = 0\text{V}$	60	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 60\text{V}$, $V_{GS} = 0\text{V}$	-	-	1.0	μA
I_{GSS}	Gate-Body Leakage Current	$V_{DS} = 0\text{V}$, $V_{GS} = \pm 20\text{V}$	-	-	± 100	nA

On Characteristics

$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250\mu\text{A}$	2.4	3	3.6	V
$R_{DS(ON)}$	Static Drain-Source ON-Resistance ⁽³⁾	$V_{GS} = 10\text{V}$, $I_D = 20\text{A}$	-	5.7	7.4	mΩ

Dynamic Characteristics

C_{iss}	Input Capacitance	$V_{GS} = 0\text{V}$, $V_{DS} = 25\text{V}$, $f = 1\text{MHz}$	-	3830	-	pF
C_{oss}	Output Capacitance		-	283	-	pF
C_{rss}	Reverse Transfer Capacitance		-	245	-	pF
Q_g	Total Gate Charge	$V_{GS} = 0$ to 10V $V_{DS} = 30\text{V}$, $I_D = 30\text{A}$	-	77	-	nC
Q_{gs}	Gate Source Charge		-	21	-	nC
Q_{gd}	Gate Drain ("Miller") Charge		-	24	-	nC

Switching Characteristics

$t_{d(on)}$	Turn-On Delay Time	$V_{GS} = 10\text{V}$, $V_{DD} = 30\text{V}$ $I_D = 30\text{A}$, $R_{GEN} = 1.8\Omega$	-	18	-	ns
t_r	Turn-On Rise Time		-	88	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	37	-	ns
t_f	Turn-Off Fall Time		-	85	-	ns

Drain-Source Diode Characteristics and Max Ratings

I_S	Maximum Continuous Drain to Source Diode Forward Current		-	-	94	A
I_{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	376	A
V_{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0\text{V}$, $I_S = 20\text{A}$	-	-	1.2	V

- Notes:
1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.
 2. E_{AS} condition: Starting $T_J = 25^\circ\text{C}$, $V_{DD} = 30\text{V}$, $V_G = 10\text{V}$, $R_G = 25\Omega$, $L = 0.5\text{mH}$, $I_{AS} = 26.5\text{A}$
 3. Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 0.5\%$.

Test Circuit

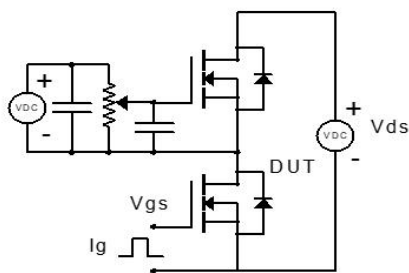


Figure 1: Gate Charge Test Circuit & Waveform



Figure 2: Resistive Switching Test Circuit & Waveform

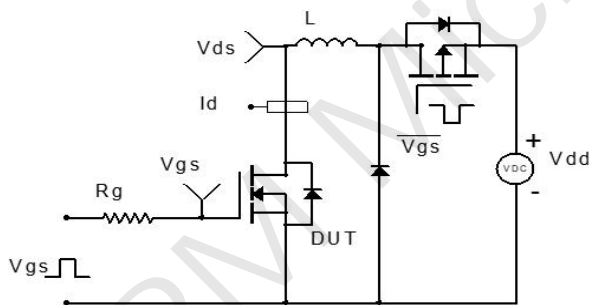
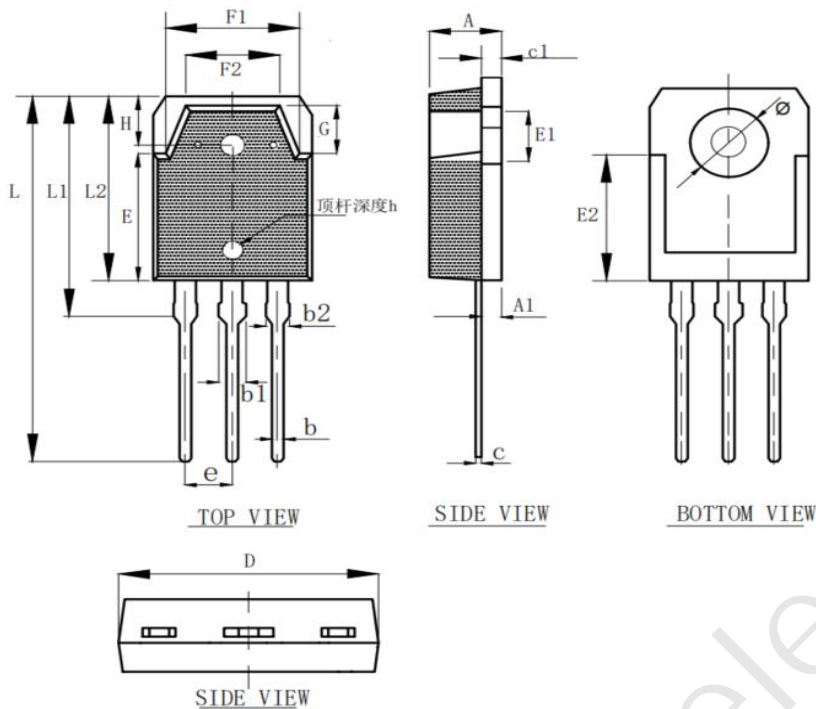


Figure 3: Unclamped Inductive Switching Test Circuit & Waveform



Figure 4: Diode Recovery Test Circuit & Waveform

Package Mechanical Data(TO-3P-3L)




SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	4.60	4.80	5.00
A1	1.20	1.40	1.60
b	0.80	1.00	1.20
b1	2.80	3.00	3.20
b2	1.80	2.00	2.20
c	0.50	0.60	0.70
c1	1.45	1.55	1.65
D	15.45	15.65	15.85
E	13.70	13.90	14.10
E1	3.30REF		
E2	12.90REF		
e	5.45TYP		
F1	13.40	13.60	13.80
F2	9.40	9.60	9.80
L	39.70	39.90	40.10
L1	23.20	23.40	23.60
L2	19.70	19.90	20.10
G	4.60	4.80	5.00
H	5.00REF		
h	0.00	0.15	0.30
Ø	3.30REF		

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